



- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

- : TO-220AB
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- : Tin plated leads, solderable per J-STD-002 and JESD22-B102
- : As marked

■ (T_a=25 Unless otherwise specified

Device marking code			MBRL3060CT
Repetitive Peak Reverse Voltage	V _{RRM}	V	60
Average Rectified Output Current @60Hz sine wave, R-load, T _a =25	I _O	A	30
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, T _a =25	I _{FSM}	A	200
Current Squared Time @1ms≤t<8.3ms T _j =25	I ² t	A ² s	167
Storage Temperature	T _{stg}		-55 ~ +150
Junction Temperature	T _j		-55 ~ +150

■ T_a=25 Unless otherwise specified

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	I _{RRM2}	V _{RM} =V _{RRM} T _a =100	20

Note1:Pulse test:300uS pulse width,1% duty cycle

Note2:Pulse test:pulse width 40mS



